

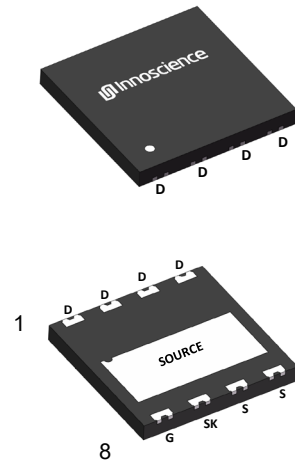
# INN650D150A

## 1. General description

650V GaN-on-silicon Enhancement-mode Power Transistor in Dual Flat No-lead package (DFN) with 8 mm × 8 mm size

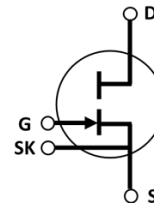
## 2. Features

- Enhancement mode transistor-Normally off power switch
- Ultra high switching frequency
- No reverse-recovery charge
- Low gate charge, low output charge
- Qualified for industrial applications according to JEDEC Standards
- ESD safeguard
- RoHS, Pb-free, REACH-compliant



## 3. Applications

- AC-DC converters
- DC-DC converters
- Totem pole PFC
- Fast battery charging
- High density power conversion
- High efficiency power conversion



## 4. Key performance parameters

**Table 1** Key performance parameters at  $T_j = 25\text{ }^\circ\text{C}$

| Parameter                                | Value | Unit       |
|--|-------|------------|
| $V_{DS,max}$                             | 650   | V          |
| $R_{DS(on),max}$ @ $V_{GS} = 6\text{ V}$ | 150   | m $\Omega$ |
| $Q_{G,typ}$ @ $V_{DS} = 400\text{ V}$    | 3     | nC         |
| $I_{D,pulse}$                            | 32    | A          |
| $Q_{OSS}$ @ $V_{DS} = 400\text{ V}$      | 28    | nC         |
| $Q_{rr}$ @ $V_{DS} = 400\text{ V}$       | 0     | nC         |

## 5. Pin information

**Table 2** Pin information

| Gate | Drain   | Kelvin Source | Source |
|------|---------|---------------|--------|
| 8    | 1,2,3,4 | 7             | 5,6    |

**Table 3** Ordering information

| Type/Ordering Code | Package | Marking (Product Code) |
|--------------------|---------|------------------------|
| INN650D150A        | DFN 8X8 | INN65D150A             |

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## 6. Maximum ratings

at  $T_j = 25\text{ }^\circ\text{C}$  unless otherwise specified.

Continuous application of maximum ratings can deteriorate transistor lifetime. For further information, contact Innoscience sales office.

**Table 4** Maximum ratings

| Parameter                                    | Symbol              | Values |      |      | Unit             | Note/Test Condition   |
|--|---------------------|--------|------|------|------------------|---|
|  |                     | Min.   | Typ. | Max. |                  |   |
| Drain source voltage                         | $V_{DS,max}$        | -      | -    | 650  | V                | $V_{GS} = 0\text{ V}$ , $I_D = 25\text{ }\mu\text{A}$   |
| Drain source voltage transient <sup>1</sup>  | $V_{DS(transient)}$ | -      | -    | 750  | V                | $V_{GS} = 0\text{ V}$ , $V_{DS} = 750\text{ V}$   |
| Continuous current, drain source             | $I_D$               | -      | -    | 17   | A                | $T_c = 25\text{ }^\circ\text{C}$  |
| Pulsed current, drain source <sup>2</sup>    | $I_{D,pulse}$       | -      | -    | 32   | A                | $T_c = 25\text{ }^\circ\text{C}$ ; $V_G = 6\text{ V}$ ;<br>See Figure 16;   |
| Pulsed current, drain source <sup>2</sup>    | $I_{D,pulse}$       | -      | -    | 23   | A                | $T_c = 125\text{ }^\circ\text{C}$ ; $V_G = 6\text{ V}$ ; See<br>Figure 17;  |
| Gate source voltage, continuous <sup>3</sup> | $V_{GS}$            | -1.4   | -    | +7   | V                | $T_j = -55\text{ }^\circ\text{C}$ to $150\text{ }^\circ\text{C}$  |
| Gate source voltage, pulsed                  | $V_{GS,pulse}$      | -20    | -    | +10  | V                | $T_j = -55\text{ }^\circ\text{C}$ to $150\text{ }^\circ\text{C}$ ;<br>$t_{PULSE} = 50\text{ ns}$ , $f = 100\text{ kHz}$<br>open drain |
| Power dissipation                            | $P_{tot}$           | -      | -    | 113  | W                | $T_c = 25\text{ }^\circ\text{C}$  |
| Operating temperature                        | $T_j$               | -55    | -    | +150 | $^\circ\text{C}$ |   |
| Storage temperature                          | $T_{stg}$           | -55    | -    | +150 | $^\circ\text{C}$ |   |

1  $V_{DS(transient)}$  is intended for surge rating during non-repetitive events,  $t_{PULSE} < 1\text{ }\mu\text{s}$

2 Pulse = 300  $\mu\text{s}$

3 The minimum  $V_{GS}$  is clamped by ESD protection circuit, as shown in Figure 10

## 7. Thermal characteristics

**Table 5** Thermal characteristics

| Parameter                         | Symbol     | Values |      |      | Unit | Note/Test Condition |
|-----------------------------------|------------|--------|------|------|------|---------------------|
|                                   |            | Min.   | Typ. | Max. |      |                     |
| Thermal resistance, junction-case | $R_{thJC}$ | -      | -    | 1.1  | °C/W |                     |
| Reflow soldering temperature      | $T_{sold}$ | -      | -    | 260  | °C   | MSL3                |

## 8. Electric characteristics

at  $T_j = 25\text{ }^\circ\text{C}$ , unless specified otherwise

**Table 6 Static characteristics**

| Parameter                        | Symbol       | Values |      |      | Unit             | Note/Test Condition   |
|----------------------------------|--------------|--------|------|------|------------------|---|
|                                  |              | Min.   | Typ. | Max. |                  |   |
| Gate threshold voltage           | $V_{GS(th)}$ | 1.2    | 1.6  | 2.2  | V                | $I_D = 17.2\text{ mA}; V_{DS} = V_{GS}; T_j = 25\text{ }^\circ\text{C}$       |
|                                  |              | -      | 1.5  | -    |                  | $I_D = 17.2\text{ mA}; V_{DS} = V_{GS}; T_j = 125\text{ }^\circ\text{C}$      |
| Drain-source leakage current     | $I_{DSS}$    | -      | 0.7  | 25   | $\mu\text{A}$    | $V_{DS} = 650\text{ V}; V_{GS} = 0\text{ V}; T_j = 25\text{ }^\circ\text{C}$  |
|                                  |              | -      | 6    | 200  |                  | $V_{DS} = 650\text{ V}; V_{GS} = 0\text{ V}; T_j = 150\text{ }^\circ\text{C}$ |
| Gate-source leakage current      | $I_{GSS}$    | -      | 30   | -    | $\mu\text{A}$    | $V_{GS} = 6\text{ V}; V_{DS} = 0\text{ V}$                                    |
| Drain-source on-state resistance | $R_{DS(on)}$ | -      | 115  | 150  | $\text{m}\Omega$ | $V_{GS} = 6\text{ V}; I_D = 5\text{ A}; T_j = 25\text{ }^\circ\text{C}$       |
|                                  |              | -      | 234  | -    |                  | $V_{GS} = 6\text{ V}; I_D = 5\text{ A}; T_j = 150\text{ }^\circ\text{C}$      |
| Gate resistance                  | $R_G$        | -      | 1.4  | -    | $\Omega$         | $f = 5\text{ MHz}; \text{open drain}$   |

**Table 7 Dynamic characteristics**

| Parameter   | Symbol       | Values |      |      | Unit | Note/Test Condition  |
|---|--------------|--------|------|------|------|--|
|   |              | Min.   | Typ. | Max. |      |  |
| Input capacitance   | $C_{iss}$    | -      | 110  | -    | pF   | $V_{GS} = 0\text{ V}; V_{DS} = 400\text{ V}; f = 100\text{ kHz}$ |
| Output capacitance  | $C_{oss}$    | -      | 30   | -    | pF   | $V_{GS} = 0\text{ V}; V_{DS} = 400\text{ V}; f = 100\text{ kHz}$ |
| Reverse transfer capacitance                              | $C_{rss}$    | -      | 0.46 | -    | pF   | $V_{GS} = 0\text{ V}; V_{DS} = 400\text{ V}; f = 100\text{ kHz}$ |
| Effective output capacitance, energy related <sup>1</sup> | $C_{o(er)}$  | -      | 42   | -    | pF   | $V_{GS} = 0\text{ V}; V_{DS} = 0\text{ to }400\text{ V}$         |
| Effective output capacitance, time related <sup>2</sup>   | $C_{o(tr)}$  | -      | 68   | -    | pF   | $V_{GS} = 0\text{ V}; V_{DS} = 0\text{ to }400\text{ V}$         |
| Output charge   | $Q_{oss}$    | -      | 28   | -    | nC   | $V_{GS} = 0\text{ V}; V_{DS} = 0\text{ to }400\text{ V}$         |
| Turn-on delay time  | $t_{d(on)}$  | -      | 3    | -    | nS   | See Figure 22  |
| Turn-off delay time                                       | $t_{d(off)}$ | -      | 7    | -    | nS   | See Figure 22  |
| Rise time   | $t_r$        | -      | 5    | -    | nS   | See Figure 22  |
| Fall time   | $t_f$        | -      | 5    | -    | nS   | See Figure 22  |

1  $C_{o(er)}$  is the fixed capacitance that gives the same stored energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 to 400 V

2  $C_{o(tr)}$  is the fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 to 400 V

**Table 8 Gate charge characteristics**

| Parameter            | Symbol     | Values |      |      | Unit | Note/Test Condition   |
|----------------------|------------|--------|------|------|------|---|
|                      |            | Min.   | Typ. | Max. |      |   |
| Gate charge          | $Q_G$      | -      | 3    | -    | nC   | $V_{GS} = 0 \text{ to } 6 \text{ V}; V_{DS} = 400 \text{ V}; I_D = 5 \text{ A}$ |
| Gate-source charge   | $Q_{GS}$   | -      | 0.28 | -    | nC   |   |
| Gate-drain charge    | $Q_{GD}$   | -      | 1.63 | -    | nC   |   |
| Gate Plateau Voltage | $V_{Plat}$ | -      | 2.3  | -    | V    | $V_{DS} = 400 \text{ V}; I_D = 5 \text{ A}$                                     |

**Table 9 Reverse conduction characteristics**

| Parameter                     | Symbol        | Values |      |      | Unit | Note/Test Condition                            |
|-------------------------------|---------------|--------|------|------|------|--|
|                               |               | Min.   | Typ. | Max. |      |  |
| Source-Drain reverse voltage  | $V_{SD}$      | -      | 2.6  | -    | V    | $V_{GS} = 0 \text{ V}; I_S = 5 \text{ A}$      |
| Pulsed current, reverse       | $I_{S,pulse}$ | -      | -    | 32   | A    | $V_{GS} = 6 \text{ V}$                         |
| Reverse recovery charge       | $Q_{rr}$      | -      | 0    | -    | nC   | $I_{SD} = 5 \text{ A}; V_{DS} = 400 \text{ V}$ |
| Reverse recovery time         | $t_{rr}$      | -      | 0    | -    | ns   |  |
| Peak reverse recovery current | $I_{rrm}$     | -      | 0    | -    | A    |  |

## 9. Electric characteristics diagrams

at  $T_j = 25\text{ }^\circ\text{C}$ , unless specified otherwise

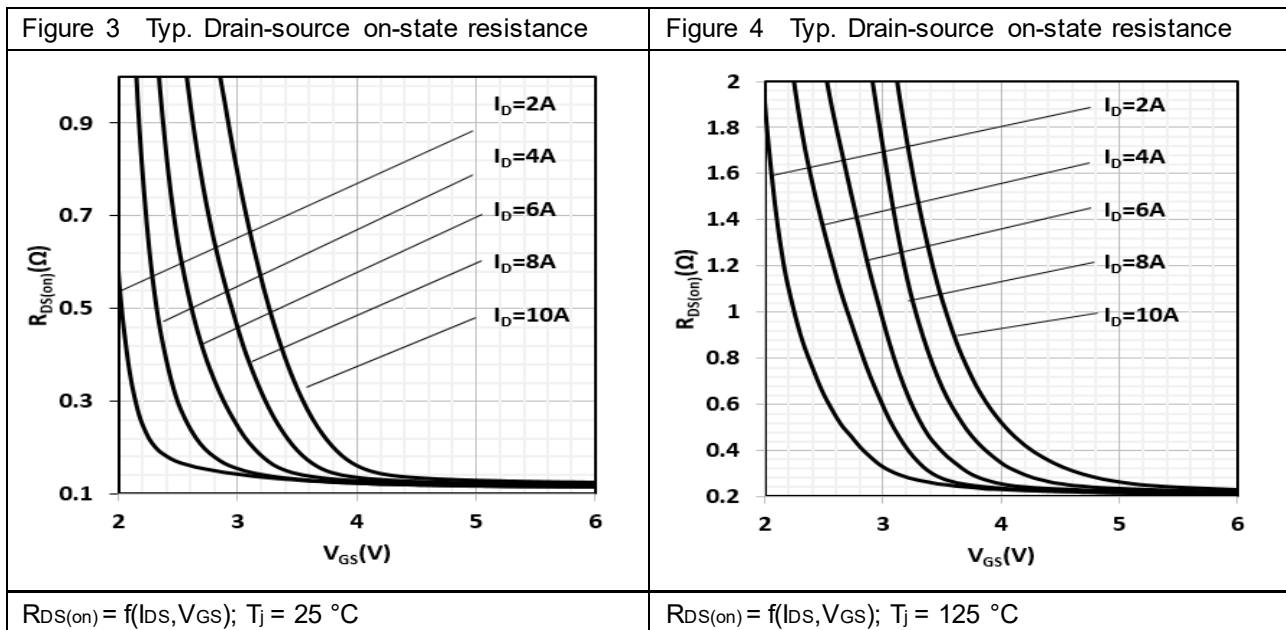
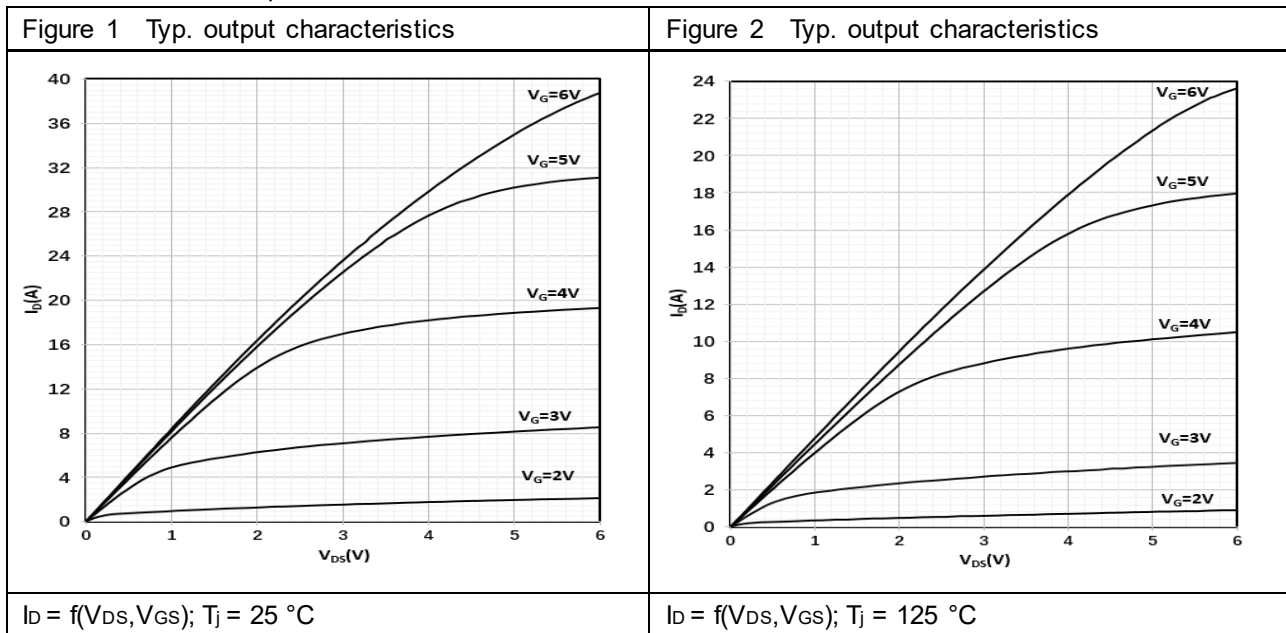
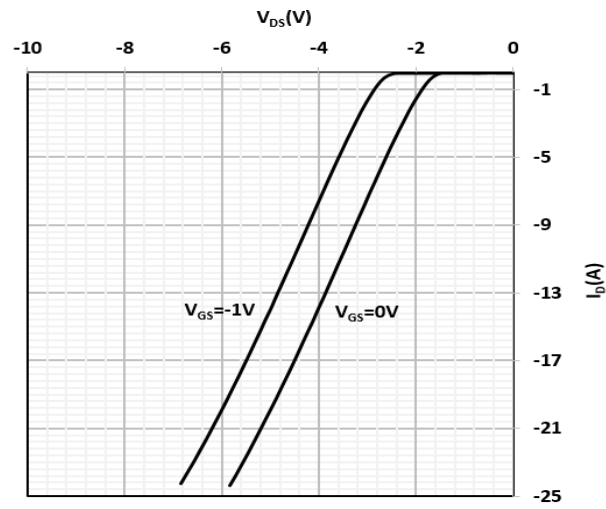
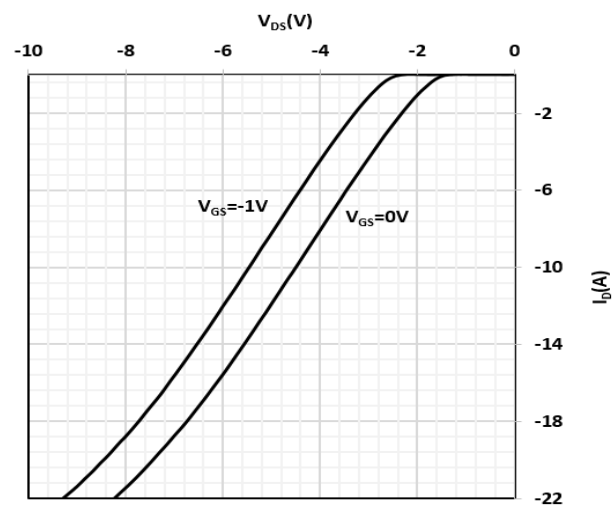


Figure 5 Typ. channel reverse characteristics



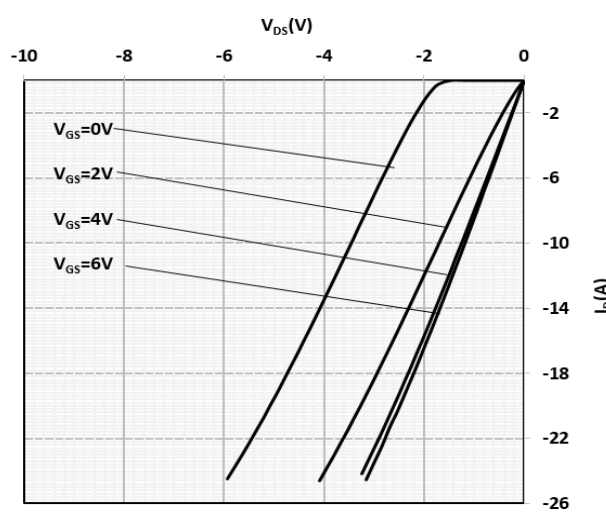
$I_D = f(V_{DS}, V_{GS}); T_j = 25\text{ }^\circ\text{C}$

Figure 6 Typ. channel reverse characteristics



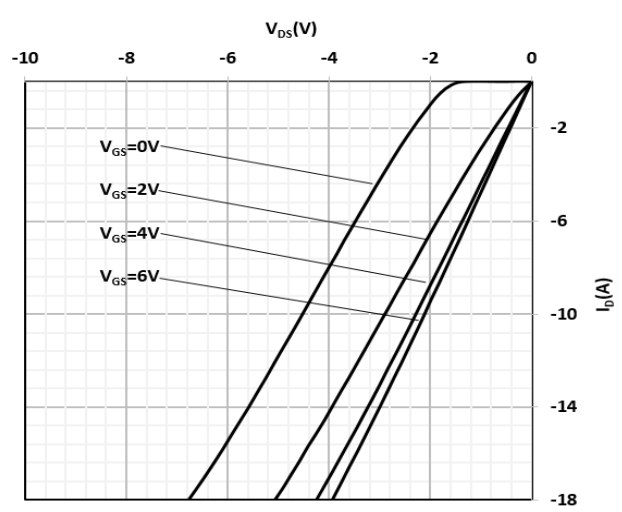
$I_D = f(V_{DS}, V_{GS}); T_j = 125\text{ }^\circ\text{C}$

Figure 7 Typ. channel reverse characteristics



$I_D = f(V_{DS}, V_{GS}); T_j = 25\text{ }^\circ\text{C}$

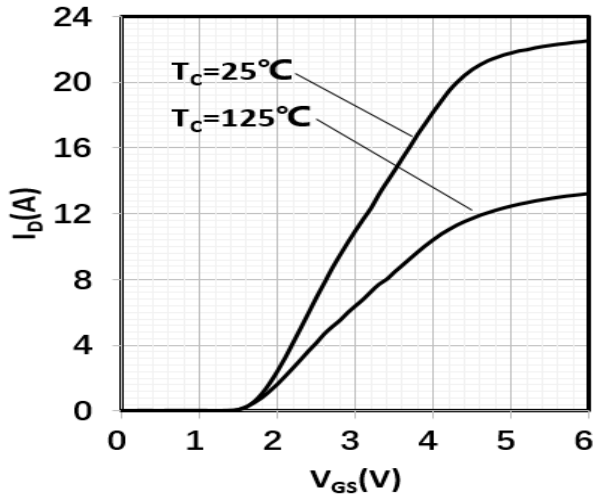
Figure 8 Typ. channel reverse characteristics



$I_D = f(V_{DS}, V_{GS}); T_j = 125\text{ }^\circ\text{C}$

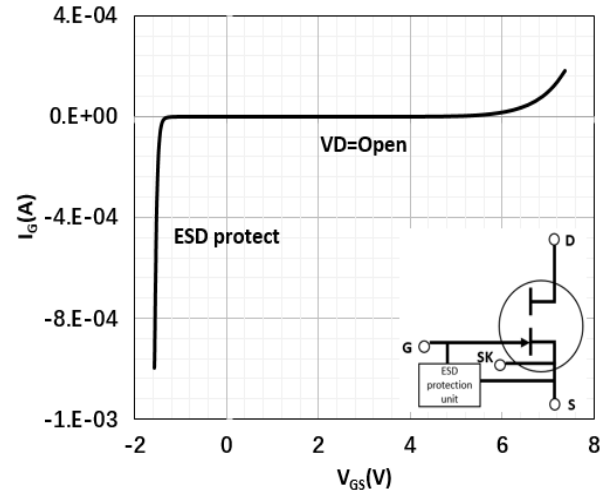


Figure 9 Typ. transfer characteristics



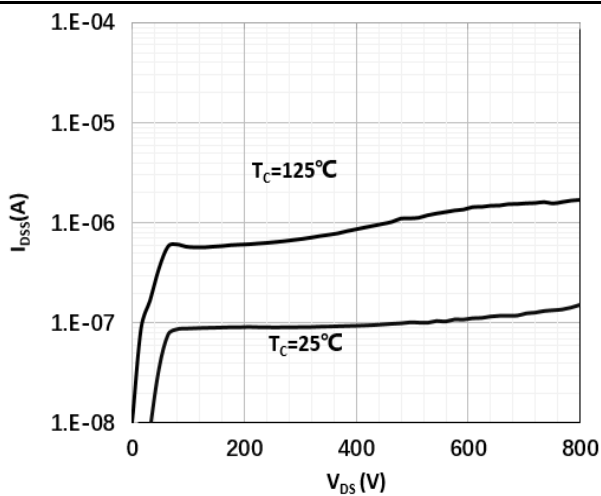
$I_D = f(V_{GS}); V_{DS} = 3\text{ V}$

Figure 10 Typ. Gate-to-Source leakage



$I_G = f(V_{GS}); I_G$  reverse turn on by ESD unit

Figure 11 Drain-source leakage characteristics



$I_{DSS} = f(V_{DS}); V_{GS} = 0\text{ V}$

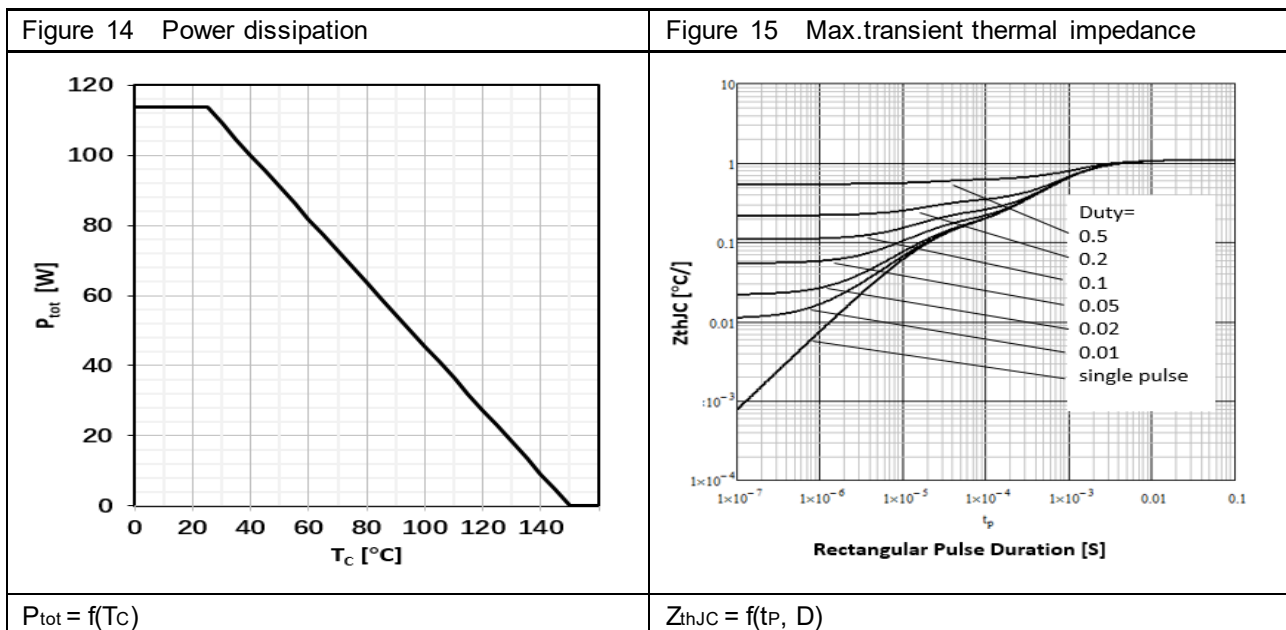
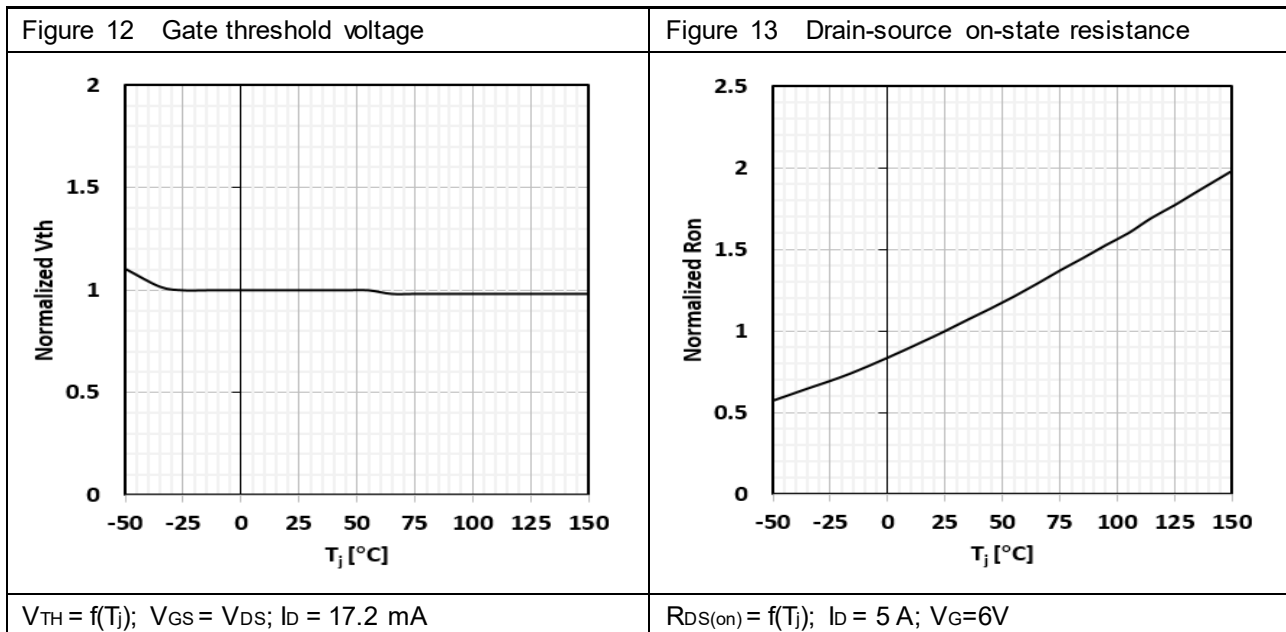
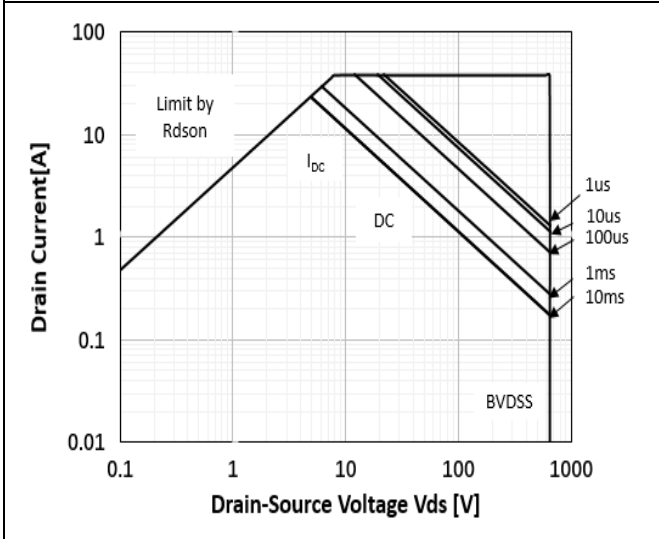
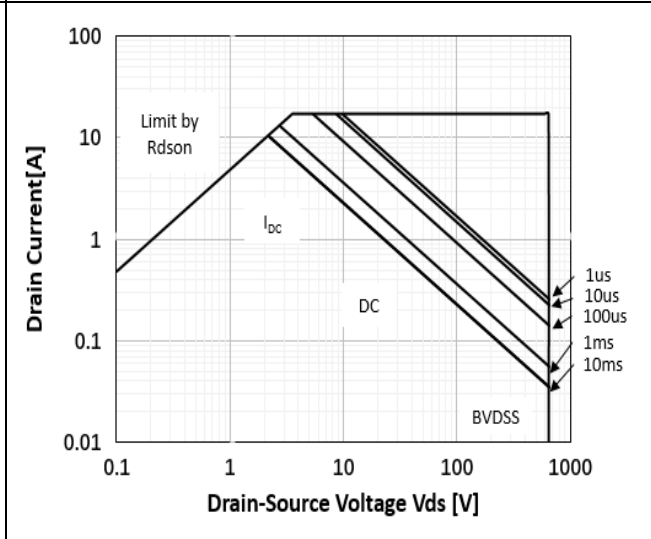


Figure 16 Safe operating area



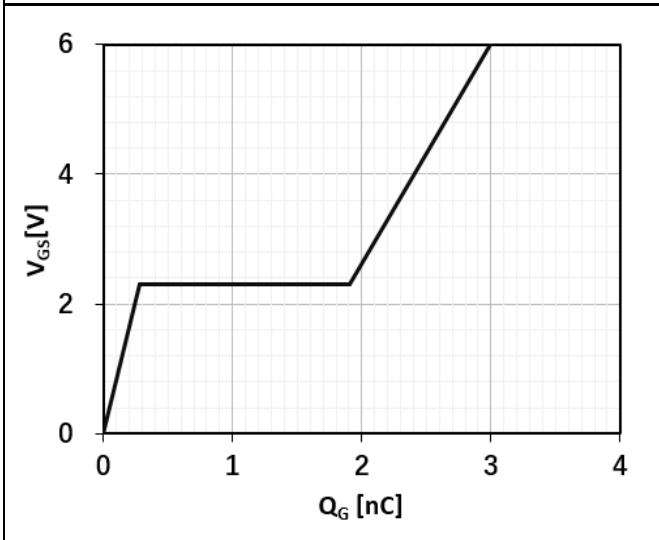
$I_D = f(V_{DS}); T_c = 25\text{ }^\circ\text{C}$

Figure 17 Safe operating area



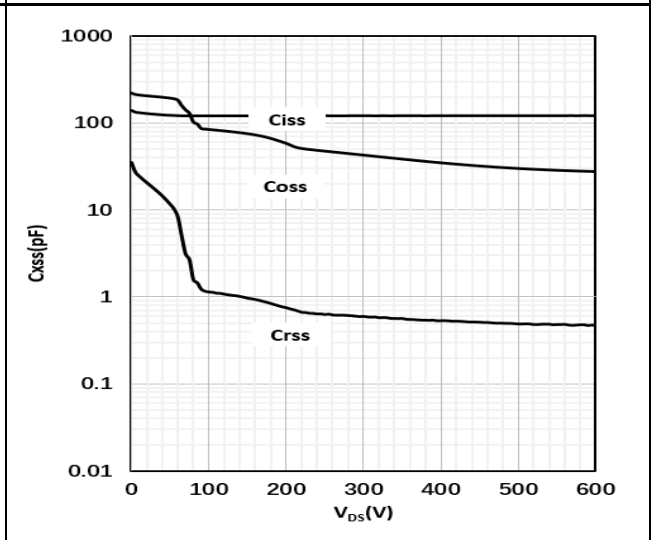
$I_D = f(V_{DS}); T_c = 125\text{ }^\circ\text{C}$

Figure 18 Typ. gate charge

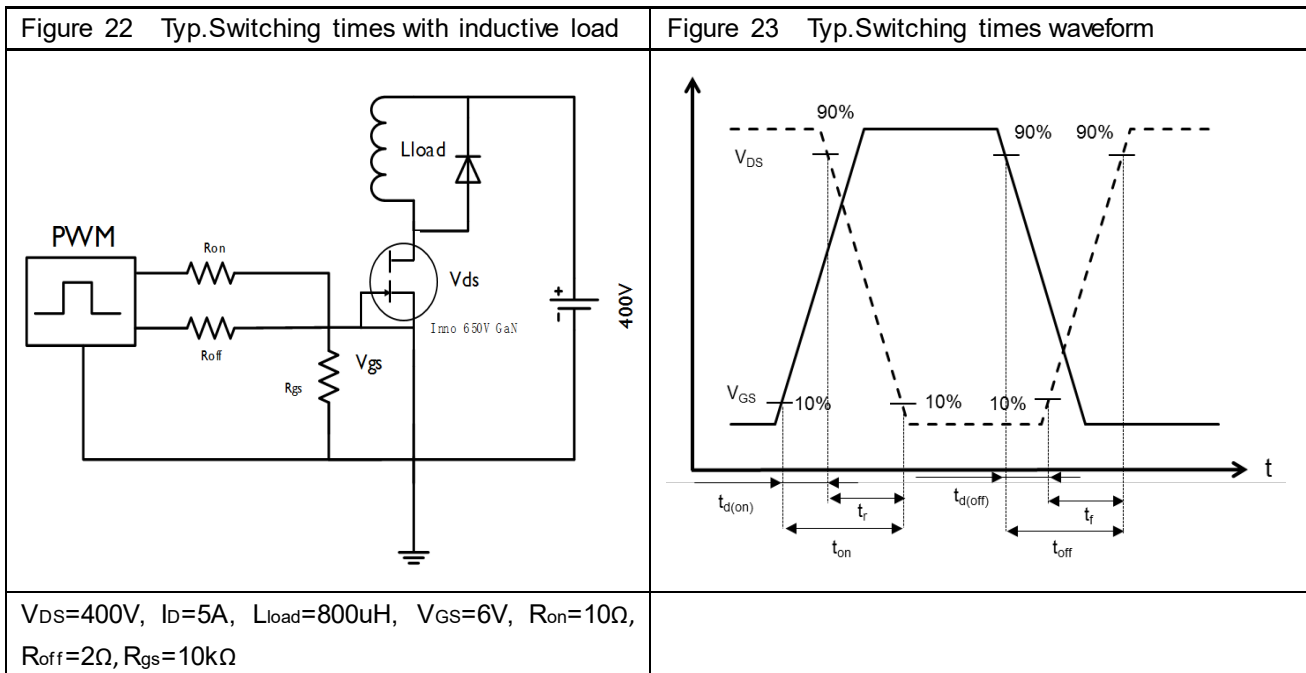
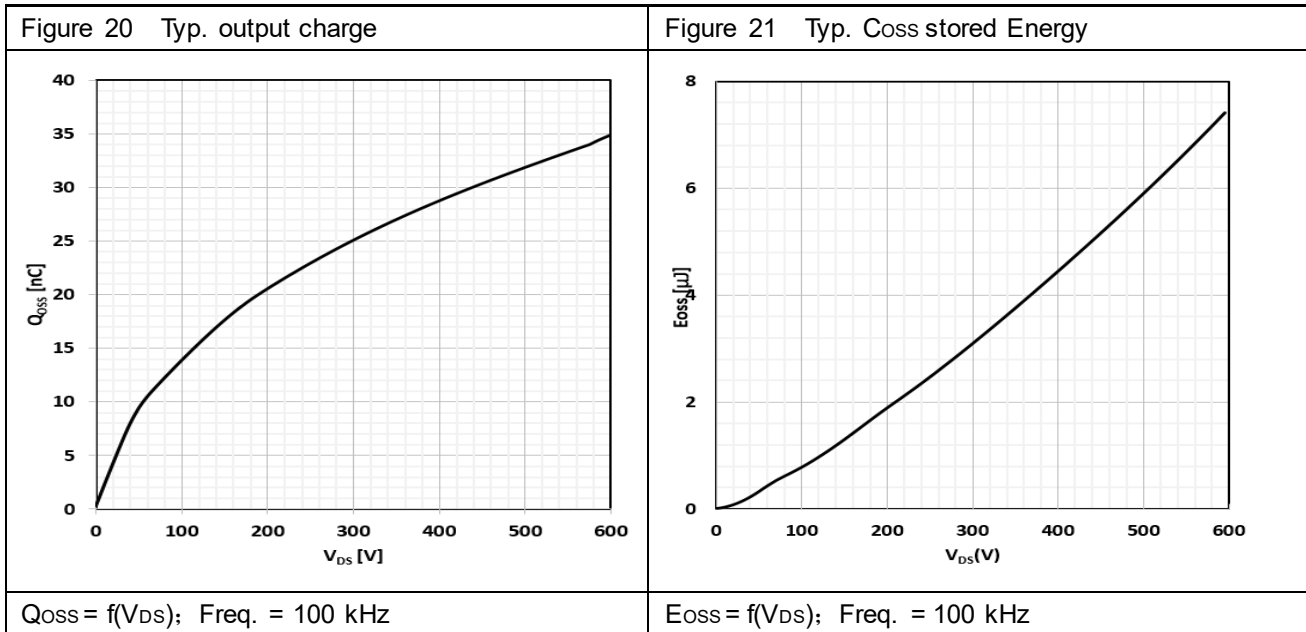


$V_{GS} = f(Q_G); V_{DCLINK} = 400\text{ V}; I_D = 5\text{ A}$

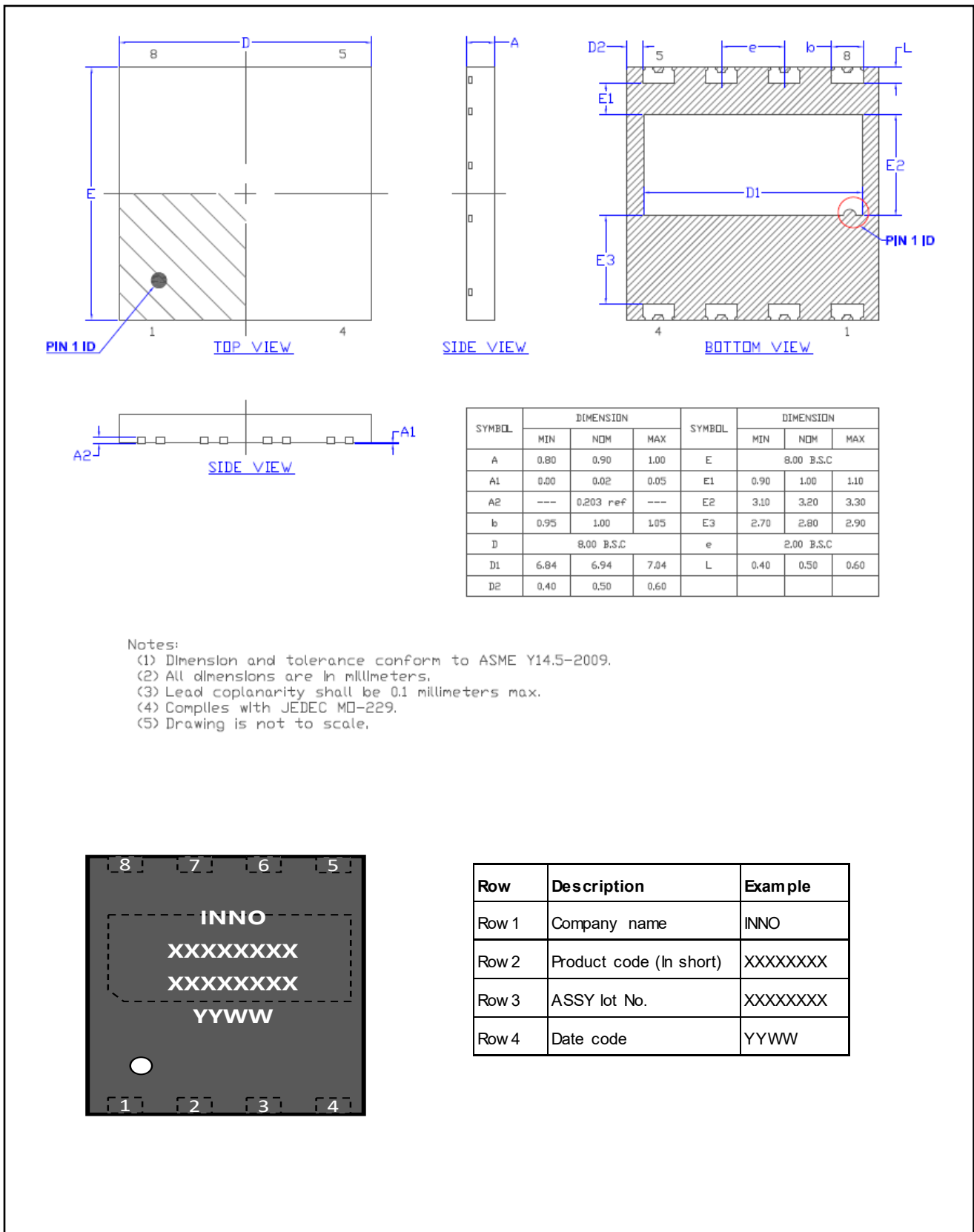
Figure 19 Typ. capacitances



$C_{XSS} = f(V_{DS}); \text{Freq.} = 100\text{ kHz}$



## 10.Package outlines



## 11.Revision history

### Major changes since the last revision

| Revision | Date      | Description of changes |
|----------|-----------|------------------------|
| 1.0      | 2021-4-26 | 1.0 version release    |

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